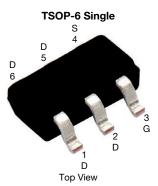


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Vishay Siliconix

# P-Channel 30 V (D-S) MOSFET



Marking code: AT

PRODUCT SUMMARY					
V <sub>DS</sub> (V)	-30				
$R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS} = -10 \text{ V}$	0.074				
$R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS} = -4.5 \text{ V}$	0.113				
Q <sub>g</sub> typ. (nC)	5.1				
I <sub>D</sub> (A) <sup>a</sup>	-5.1				
Configuration	Single				

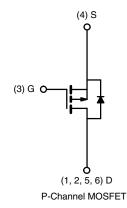
#### **FEATURES**

- TrenchFET® power MOSFET
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>



#### **APPLICATIONS**

· Load switch



ORDERING INFORMATION	
Package	TSOP-6
Lead (Pb)-free	Si3457CDV-T1-E3
Lead (Pb)-free and halogen-free	Si3457CDV-T1-GE3

ABSOLUTE MAXIMUM RATING	<b>iS</b> (T <sub>A</sub> = 25 °C, u	nless otherv	vise noted)		
PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-source voltage		$V_{DS}$	-30	V	
Gate-source voltage		$V_{GS}$	± 20	v	
	T <sub>C</sub> = 25 °C		-5.1		
Continuous drain ourrent (T = 150 °C)	T <sub>C</sub> = 70 °C		-4.1		
Continuous drain current (T <sub>J</sub> = 150 °C)	T <sub>A</sub> = 25 °C	l <sub>D</sub>	-4.1 b, c		
	T <sub>A</sub> = 70 °C	1	-3.3 b, c	Α	
Pulsed drain current		I <sub>DM</sub>	-20		
Continuous source drain diade surrent	T <sub>C</sub> = 25 °C		-2.5		
Continuous source-drain diode current	T <sub>A</sub> = 25 °C	l <sub>S</sub>	-1.67 <sup>b, c</sup>		
	T <sub>C</sub> = 25 °C		3		
Maximum power dissipation	T <sub>C</sub> = 70 °C		2	10/	
	T <sub>A</sub> = 25 °C	P <sub>D</sub>	2 b, c	W	
	T <sub>A</sub> = 70 °C	1	1.3 <sup>b, c</sup>		
Operating junction and storage temperature range		T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C	

THERMAL RESISTANCE RATINGS						
PARAMETER		SYMBOL	TYPICAL	MAXIMUM	UNIT	
Maximum junction-to-ambient b, d	t ≤ 5 s	R <sub>thJA</sub>	55	62.5	°C/W	
Maximum junction-to-foot (drain)	Steady state	$R_{thJF}$	34	41	]	

#### Notes

- a. Based on  $T_C$  = 25  $^{\circ}C$
- b. Surface mounted on 1" x 1" FR4 board
- c. t = 5 s
- d. Maximum under steady state conditions is 110 °C/W

# Vishay Siliconix

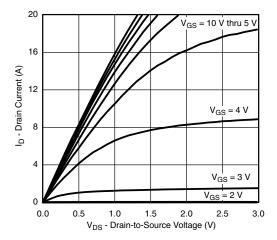
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static	<u> </u>		•		•	
Drain-source breakdown voltage	$V_{DS}$	$V_{GS} = 0 \text{ V}, I_D = -250 \mu\text{A}$	-30	-	-	V
V <sub>DS</sub> temperature coefficient	$\Delta V_{DS}/T_{J}$	J 050 A	-	-31	-	mV/°C
V <sub>GS(th)</sub> temperature coefficient	$\Delta V_{GS(th)}/T_J$	I <sub>D</sub> = -250 μA	-	4.5	-	
Gate-source threshold voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_D = -250 \mu A$	-1	-	-3	V
Gate-source leakage	I <sub>GSS</sub>	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$	-	-	± 100	nA
Zana mata walka sa alusin awana t		V <sub>DS</sub> = -30 V, V <sub>GS</sub> = 0 V	-	-	-1	μΑ
Zero gate voltage drain current	I <sub>DSS</sub>	V <sub>DS</sub> = -30 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 55 °C	-	-	-10	
On-state drain current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \le -5 \text{ V}, V_{GS} = -10 \text{ V}$	-20	-	-	Α
Data and a state and a second	_	$V_{GS} = -10 \text{ V}, I_D = -4.1 \text{ A}$	-	0.060	0.074	
Drain-source on-state resistance a	R <sub>DS(on)</sub>	V <sub>GS</sub> = -4.5 V, I <sub>D</sub> = -1 A	-	0.092	0.113	Ω
Forward transconductance a	9 <sub>fs</sub>	V <sub>DS</sub> = -15 V, I <sub>D</sub> = -4.1 A	-	8	-	S
Dynamic <sup>b</sup>			•		•	•
Input capacitance	C <sub>iss</sub>		-	450	-	pF
Output capacitance	C <sub>oss</sub>	$V_{DS} = -15 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$	-	80	-	
Reverse transfer capacitance	C <sub>rss</sub>		-	63	-	
Total mate aboves	Qg	V <sub>DS</sub> = -15 V, V <sub>GS</sub> = -10 V, I <sub>D</sub> = -4.1 A	-	10	15	
Total gate charge			-	5.1	8	
Gate-source charge	$Q_{gs}$	$V_{DS} = -15 \text{ V}, V_{GS} = -4.5 \text{ V}, I_{D} = -4.1 \text{ A}$	-	1.8	-	nC
Gate-drain charge	$Q_{gd}$		-	2.5	-	
Gate resistance	$R_g$	f = 1 MHz	-	7	-	Ω
Turn-on delay time	t <sub>d(on)</sub>		-	40	60	
Rise time	t <sub>r</sub>	$V_{DD}$ = -15 V, $R_L$ = 4.6 $\Omega$	-	80	120	
Turn-off delay time	t <sub>d(off)</sub>	$I_D \cong -3.3 \text{ A}, V_{GEN} = -4.5 \text{ V}, R_g = 1 \Omega$	-	20	30	
Fall time	t <sub>f</sub>		-	12	20	
Turn-on delay time	t <sub>d(on)</sub>		-	5	10	ns
Rise time	t <sub>r</sub>	$V_{DD}$ = -15 V, $R_L$ = 4.6 $\Omega$	-	13	20	1 - -
Turn-off delay time	t <sub>d(off)</sub>	$I_D\cong$ -3.3 A, $V_{GEN}=$ -10 V, $R_g=$ 1 $\Omega$	-	20	30	
Fall time	t <sub>f</sub>		-	10	15	
<b>Drain-Source Body Diode Characteristi</b>	cs					
Continuous source-drain diode current	Is	T <sub>C</sub> = 25 °C	-	-	-2.5	Α
Pulse diode forward current <sup>a</sup>	I <sub>SM</sub>		-	-	-20	_ ^
Body diode voltage	$V_{SD}$	I <sub>S</sub> = -3.3 A	-	-0.8	-1.2	V
Body diode reverse recovery time	t <sub>rr</sub>		-	20	30	ns
Body diode reverse recovery charge	Q <sub>rr</sub>	$I_F = -3.3 \text{ A}, \text{ di/dt} = 100 \text{ A/}\mu\text{s},$	-	20	30	nC
Reverse recovery fall time	t <sub>a</sub>	T <sub>J</sub> = 25 °C	-	14	-	
Reverse recovery rise time	t <sub>b</sub>		-	6	-	ns

#### Notes

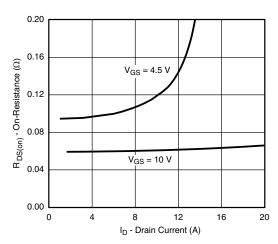
- a. Pulse test; pulse width  $\leq$  300  $\mu$ s, duty cycle  $\leq$  2 %
- b. Guaranteed by design, not subject to production testing

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

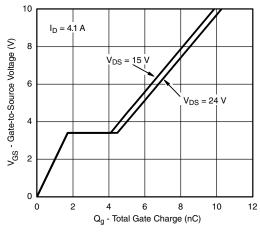




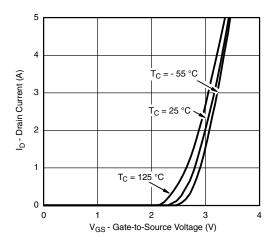
#### **Output Characteristics**



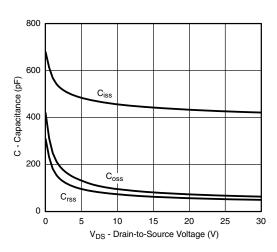
On-Resistance vs. Drain Current and Gate Voltage



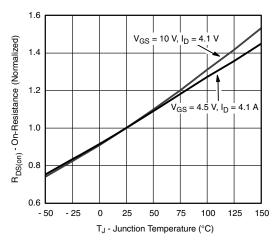
**Gate Charge** 



**Transfer Characteristics** 

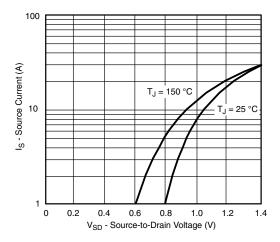


Capacitance

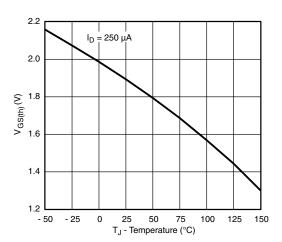


On-Resistance vs. Junction Temperature

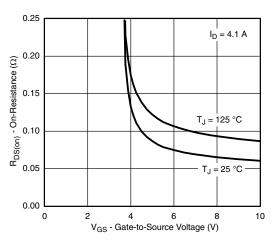




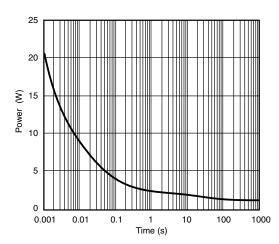
#### Source-Drain Diode Forward Voltage



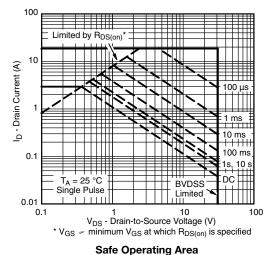
**Threshold Voltage** 



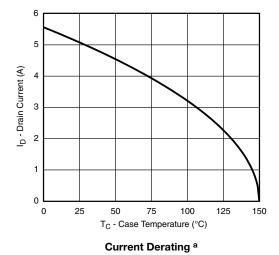
On-Resistance vs. Gate-to-Source Voltage

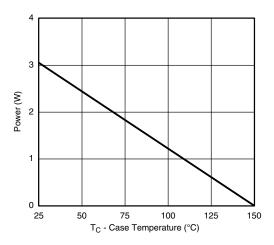


Single Pulse Power







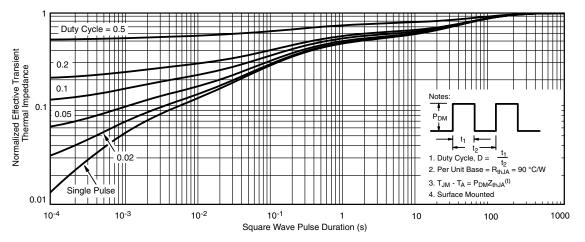


Power, Junction-to-Foot

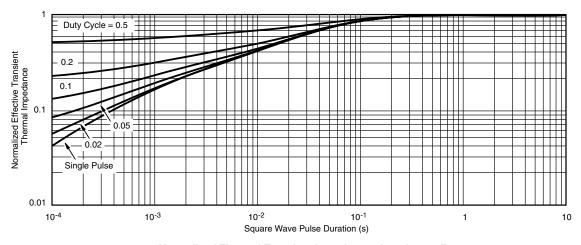
#### Notes

a. The power dissipation P<sub>D</sub> is based on T<sub>J</sub> max. = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit





Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Foot

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TSOP: 5/6-LEAD

**JEDEC Part Number: MO-193C** 





**5-LEAD TSOP** 







	MIL	LIMETER	RS	INCHES			
Dim	Min	Nom	Max	Min	Nom	Max	
Α	0.91	-	1.10	0.036	-	0.043	
A <sub>1</sub>	0.01	-	0.10	0.0004	-	0.004	
A <sub>2</sub>	0.90	-	1.00	0.035	0.038	0.039	
b	0.30	0.32	0.45	0.012	0.013	0.018	
С	0.10	0.15	0.20	0.004	0.006	0.008	
D	2.95	3.05	3.10	0.116	0.120	0.122	
E	2.70	2.85	2.98	0.106	0.112	0.117	
E <sub>1</sub>	1.55	1.65	1.70	0.061	0.065	0.067	
е		0.95 BSC		0.0374 BSC			
e <sub>1</sub>	1.80	1.90	2.00	0.071	0.075	0.079	
L	0.32	-	0.50	0.012	-	0.020	
L <sub>1</sub>		0.60 Ref			0.024 Ref		
L <sub>2</sub>	0.25 BSC			0.010 BSC			
R	0.10	-	-	0.004	-	-	
θ	0°	4°	8°	0°	4°	8°	
θ1	7° Nom			7° Nom			
ECN: C-06593-Rev. I, 18-Dec-06 DWG: 5540							

Document Number: 71200 18-Dec-06



## Recommended Land Pattern For TSOP-5L / TSOP-6L



#### Note

• All dimensions are in inches (millimeter)

ECN: C22-0860-Rev. B, 24-Oct-2022 DWG: 3010



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